The background features a complex, abstract pattern of concentric, swirling lines in various shades of blue and green. The lines are dense and create a sense of motion and depth, resembling a stylized, organic form or a digital data visualization. The colors transition from a deep blue on the left to a vibrant cyan and then to a bright green on the right.

Performance  
made flexible.

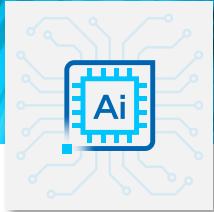


# Himanshu Saluja

Business Development Director,

APJ & EMEA | Team Oracle

# Business Needs and Demands are Dynamically Shifting





# Future of the Data Center

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Compute, storage, and memory will be increasingly disaggregated.

Security architected-in at the chip level

Software deployed as smaller units called Microservices

CPUs and XPU's will work together to solve complex challenges

# Unmatched Portfolio of Hardware, Software and Solutions

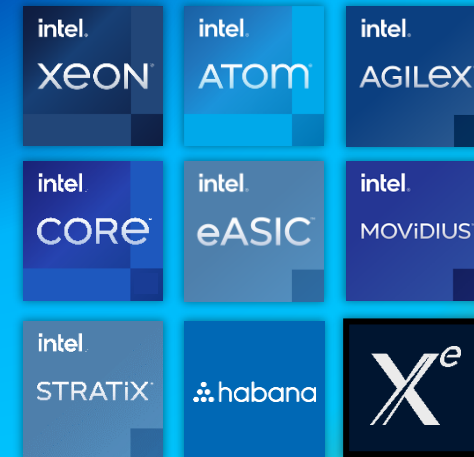
## Move Faster



## Store More



## Process Everything



Optimized Software and System-Level Solutions

INTRODUCING

# 3rd Gen Intel® Xeon® Scalable processors

## Performance made flexible

Only x86 data center processor with  
built-in AI & security solutions



### Advanced security solutions



Intel Software  
Guard Extensions



Intel  
Crypto  
Acceleration

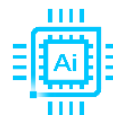


Intel Total Memory  
Encryption



Intel Platform  
Firmware  
Resilience

### Scalable, flexible, customizable



Intel Deep  
Learning Boost



Intel Speed Select  
Technology



Intel  
AVX-512



oneAPI  
POWERED  
Optimized  
Software

Targeted for 1S-2S systems

### Next-gen Xeon Scalable Platform

Up to  
**6TB**

System Memory  
Capacity  
(Per Socket)  
DRAM + PMem

Up to  
**8CH**

DDR4-3200  
2 DPC  
(Per Socket)

Up to  
**2.6X**

Memory Capacity  
Increase vs.  
2nd Gen Xeon  
Scalable

Up to  
**64**

Lanes  
PCI Express 4  
(per Socket)

### Breakthrough Data Performance

OPTANE



Intel®  
Optane™  
persistent  
memory 200  
series

OPTANE



Intel®  
Optane™  
SSD P5800X  
series



Intel® SSD  
D series

### Faster, Flexible, Data Scale



Intel® Ethernet  
800 series  
network adapters



Intel® Agilex™  
FPGA  
solutions

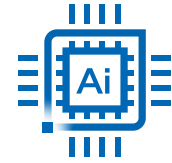
intel  
**SELECT  
SOLUTIONS**

intel  
**MARKET  
READY**

Performance made flexible.

# Flexible Performance for Most Demanding Workloads

Outstanding gen-on-gen performance from intelligent edge to cloud



## Cloud

UP TO

**1.5x**

Improvement in  
Latency Sensitive  
Workloads

## 5G

UP TO

**1.62x**

Improvement  
in Network and  
Communications  
Workloads

## IoT

UP TO

**1.56x**

Image Classification  
Inference  
Improvement

## HPC

UP TO

**1.57x**

Faster Modeling  
for Critical Vaccine  
Research

## Artificial Intelligence

UP TO

**1.74x**


Language  
Processing  
Inference  
Improvements

Performance varies by use, configuration and other factors. Configurations see appendix [5,7,17,19,52]

# Intel® Optane™ Persistent Memory 200 Series

## Persistent memory made flexible

Average of  
**32%** higher  
memory bandwidth  
compared to 100 series



Up to  
**6** TB total memory  
per socket  
for faster analysis of the  
largest data sets

intel.  
**OPTANE**  
PERSISTENT  
MEMORY

**eADR (Enhanced Asynchronous DRAM Refresh)** improves performance of apps that use persistent memory by eliminating “cache flushes” – volatile data including the CPU caches save automatically, even if power fails

Intel Optane PMem 200 series is compatible with existing PMem SW ecosystem & it continues to grow

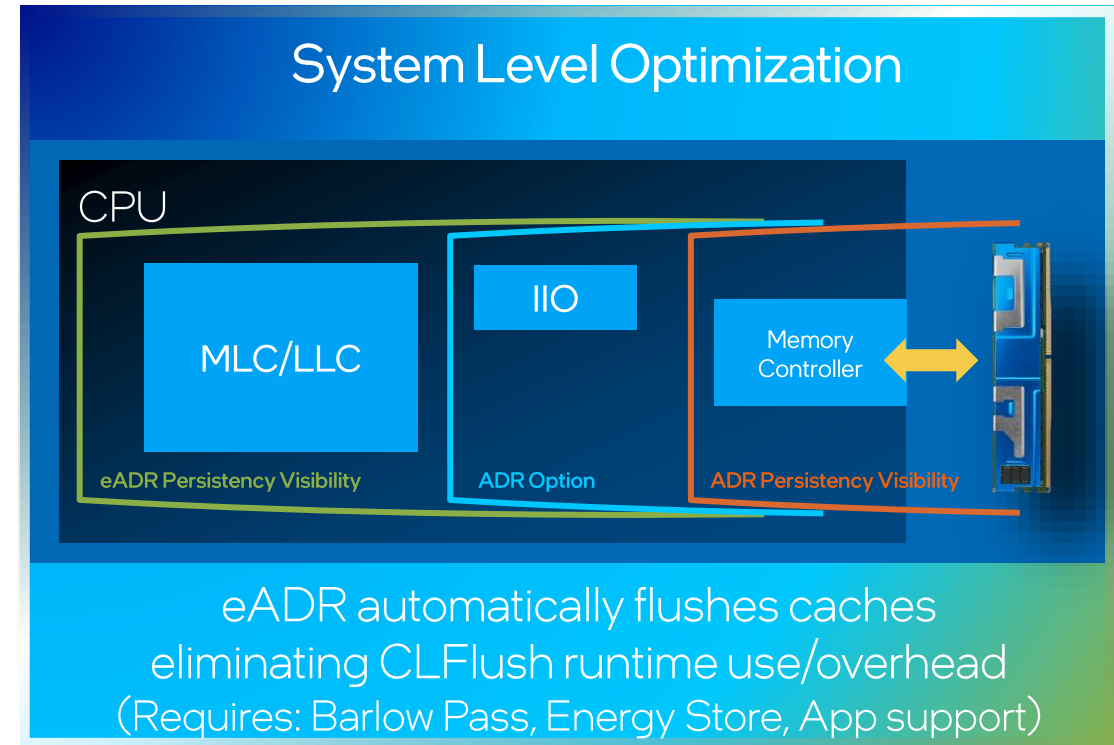
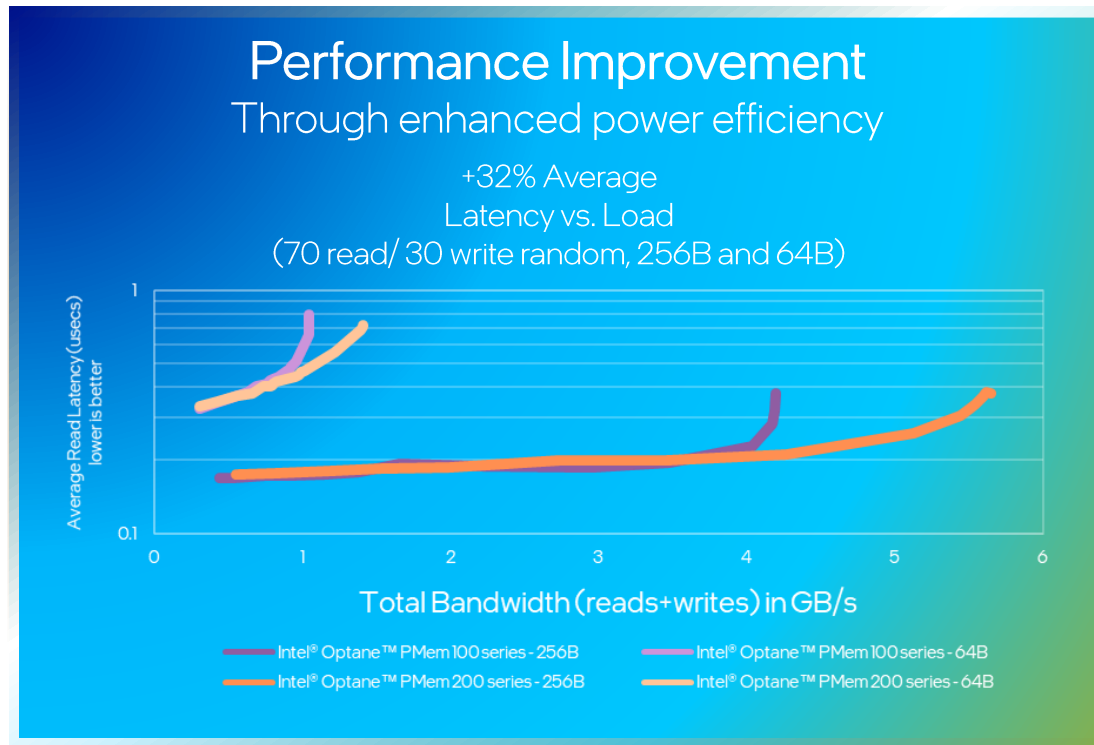
Computes up to **2X** faster graph analytics algorithms used in search, social networks, and fraud detection

Lower infrastructure costs by up **25%** per VM while delivering the same performance

Performance varies by use, configuration and other factors. Configurations see appendix [53]



# Intel® Optane™ Persistent Memory 200 Series (Barlow Pass)



## Intel® Optane™ Persistent Memory 200 Series

- Consistent developer target: capacity, latency...
- Increased bandwidth, better power efficiency
- Cross system innovation for increased application performance



# Better Together

ORACLE®



A PERFORMANCE IMPROVEMENT OF

**10x**

Lower latency

**2.5x**

Increase in online transaction processing performance.

Source: Oracle; Compared with the X8 and its InfiniBand fabric, the X8M will offer 100Gb RDMA over Converged Ethernet (RoCE) as the internal fabric to deliver latency of under 19 microseconds (10X improvement over the X8). With 1.5TB of persistent memory (PMEM) per storage server and up to 21.5TB of PMEM per standard full rack, organizations can achieve up to 16 million OLTP 8K read IOPS, 2.5X the X8.

# Summary



- Intel's highest performing data center processor with built-in security and AI and crypto acceleration
- Unmatched portfolio of hardware and software solutions to move, store and process data
- Broadest ecosystem and decades of experience to ease customer deployments

# Notices and Disclaimers

Performance varies by use, configuration and other factors. Learn more at [www.Intel.com/PerformanceIndex](http://www.Intel.com/PerformanceIndex).

Performance results are based on testing as of dates shown in configurations and may not reflect all publicly available updates. See backup for configuration details. No product or component can be absolutely secure.

Intel contributes to the development of benchmarks by participating in, sponsoring, and/or contributing technical support to various benchmarking groups, including the BenchmarkXPRT Development Community administered by Principled Technologies.

Your costs and results may vary.

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Some results may have been estimated or simulated.

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